Please read this notice before using the TAIYO YUDEN products.

!\ REMINDERS

Product information in this catalog is as of October 2013. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

 It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage

of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.

Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

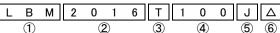




REFLOW

■PARTS NUMBER

*Operating Temp. : -40~+105°C (Including self-generated heat)



>	
Δ	
	l
(C)	



1)Series name	

Code	Series name
LBM	Wound chip inductor for signal line

②Dimensions (L × W)

9 - ····-··- (= ···)						
Code	Dimensions (L × W) [mm]					
2016	2.0 × 1.6					

3 Packaging

3 Fackaging					
Code	Packaging				
T	Taping				

4 Nominal inductance

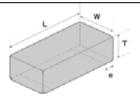
Code (example)	Nominal inductance[μ H]
R12	0.12
1R0	1.00
100	10
101	100

(5)Inductance tolerance

Code	Inductance tolerance
J	±5%

6 Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

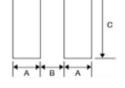


Recommended Land Patterns

Surface Mounting

- •Mounting and soldering conditions should be checked beforehand.
- •Applicable soldering process to these products is reflow soldering only.

Туре	Α	В	С
LBM2016	0.6	1.0	1.8
			Unit:mm



Туре		w	т		Standard qu	uantity [pcs]
Type	L	VV	'	е	Paper tape	Embossed tape
LBM2016	2.0±0.2 (0.08±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.02±0.008)	_	2000

Unit:mm(inch)

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●LBM2016 type		1	1					
Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Q (min.)	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω]($\pm 30\%$)	Rated current [mA] (max.)	Measuring frequency [MHz]
LBM 2016TR12J	RoHS	0.12	±5%	30	600	0.13	610	25.2
LBM 2016TR15J	RoHS	0.15	±5%	30	550	0.15	570	25.2
LBM 2016TR18J	RoHS	0.18	±5%	30	500	0.15	560	25.2
LBM 2016TR22J	RoHS	0.22	±5%	30	450	0.20	520	25.2
LBM 2016TR27J	RoHS	0.27	±5%	30	425	0.21	510	25.2
LBM 2016TR33J	RoHS	0.33	±5%	30	400	0.21	490	25.2
LBM 2016TR39J	RoHS	0.39	±5%	30	375	0.26	440	25.2
LBM 2016TR47J	RoHS	0.47	±5%	30	350	0.26	430	25.2
LBM 2016TR56J	RoHS	0.56	±5%	30	300	0.29	410	25.2
LBM 2016TR68J	RoHS	0.68	±5%	30	270	0.32	400	25.2
LBM 2016TR82J	RoHS	0.82	±5%	30	250	0.34	390	25.2
LBM 2016T1R0J	RoHS	1.0	±5%	30	220	0.38	385	7.96
LBM 2016T1R2J	RoHS	1.2	±5%	30	180	0.41	370	7.96
LBM 2016T1R5J	RoHS	1.5	±5%	30	135	0.47	350	7.96
LBM 2016T1R8J	RoHS	1.8	±5%	30	100	0.48	345	7.96
LBM 2016T2R2J	RoHS	2.2	±5%	30	75	0.54	340	7.96
LBM 2016T2R7J	RoHS	2.7	±5%	30	55	0.59	310	7.96
LBM 2016T3R3J	RoHS	3.3	±5%	30	48	0.68	290	7.96
LBM 2016T3R9J	RoHS	3.9	±5%	30	43	0.74	275	7.96
LBM 2016T4R7J	RoHS	4.7	±5%	30	40	0.78	270	7.96
LBM 2016T5R6J	RoHS	5.6	±5%	25	36	0.88	255	7.96
LBM 2016T6R8J	RoHS	6.8	±5%	25	33	0.97	240	7.96
LBM 2016T8R2J	RoHS	8.2	±5%	25	30	1.1	225	7.96
LBM 2016T100J	RoHS	10	±5%	25	27	1.2	215	2.52
LBM 2016T120J	RoHS	12	±5%	25	23	1.4	200	2.52
LBM 2016T150J	RoHS	15	±5%	25	20	1.5	190	2.52
LBM 2016T180J	RoHS	18	±5%	25	18	2.5	150	2.52
LBM 2016T220J	RoHS	22	±5%	25	17	2.8	140	2.52
LBM 2016T270J	RoHS	27	±5%	25	16	3.2	130	2.52
LBM 2016T330J	RoHS	33	±5%	25	15	3.6	125	2.52
LBM 2016T390J	RoHS	39	±5%	20	14	3.9	120	2.52
LBM 2016T470J	RoHS	47	±5%	20	13	4.1	115	2.52
LBM 2016T560J	RoHS	56	±5%	20	12	5.9	95	2.52
LBM 2016T680J	RoHS	68	±5%	20	11	7.0	90	2.52
LBM 2016T820J	RoHS	82	±5%	20	10	7.7	85	2.52
LBM 2016T101J	RoHS	100	±5%	15	9.0	8.0	80	0.796

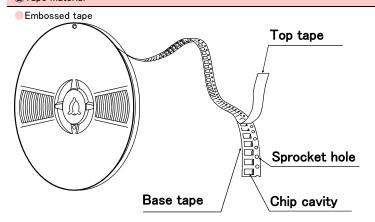
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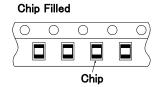
WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

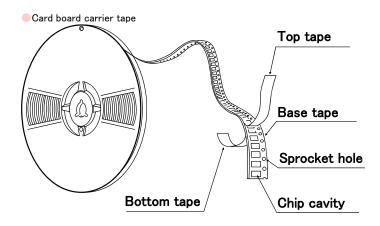
PACKAGING

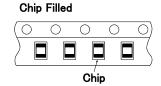
1 Minimum Quantity Standard Quantity [pcs] Туре Paper Tape Embossed Tape LB C3225 1000 CB C3225 LB 3218 2000 LB R2518 LB C2518 2000 LB 2518 CB 2518 CB C2518 LBM2016 LB C2016 LB 2016 2000 CB 2016 CB C2016 LB 2012 LB C2012 LB R2012 3000 CB 2012 CB C2012 CB L2012 4000 LB 1608 4000 LBMF1608 3000 CBMF1608

②Tape material



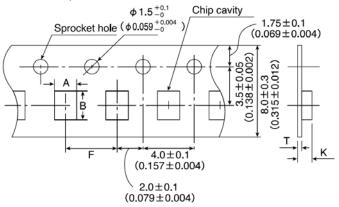






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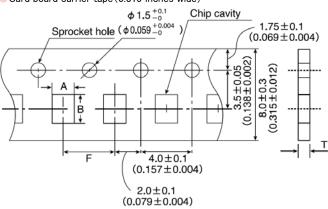
Embossed Tape (0.315 inches wide)



Т	Chip cavity		Insertion pitch	Insertion pitch Tape thickness	
Туре	Α	В	F	Т	K
LBM2016	1.75±0.1	2.1±0.1	4.0±0.1	0.3±0.05	1.9max.
	(0.069±0.004)	(0.083±0.004)	(0.157±0.004)	(0.012±0.002)	(0.075max.)
LB C3225	2.8±0.1	3.5±0.1	4.0±0.1	0.3±0.05	4.0max.
CB C3225	(0.110±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.157max.)
LB 3218	2.1±0.1	3.5±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.083±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1	2.7±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.085±0.004)	(0.106±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
LBMF1608	1.1±0.1	1.9±0.1	4.0±0.1	0.25±0.05	1.2max.
CBMF1608	(0.043±0.004)	(0.075±0.004)	(0.157±0.004)	(0.010±0.002)	(0.047max.)

Unit:mm(inch)

Card board carrier tape (0.315 inches wide)

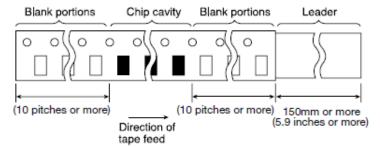


T	Chip	cavity	Insertion pitch	Tape thickness
Туре	Α	В	F	Т
CB L2012	1.55±0.1	2.3±0.1	4.0±0.1	1.1max.
OB LZUIZ	(0.061 ± 0.004)	(0.091 ± 0.004)	(0.157 ± 0.004)	(0.043max.)
LB 1608	1.0±0.1	1.8±0.1	4.0±0.1	1.1max.
LB 1608	(0.039 ± 0.004)	(0.071 ± 0.004)	(0.157 ± 0.004)	(0.043max.)

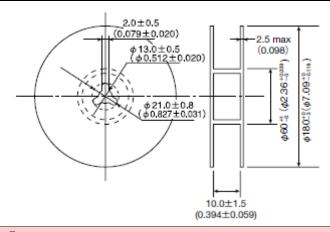
Unit:mm(inch)

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4 Leader and Blank Portion



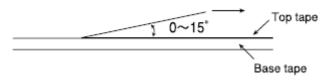
⑤Reel Size



©Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.

Pull direction



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WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

■ RELIABILITY DATA

1.Operating temper	ature Range	
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	-40~+105°C (Including self-generated heat)
	LBM Series	
2. Storage Tempera	ture Range (after soldering)	
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	-40~+85°C
	LBM Series	
Test Methods and	LB, CB Series:	
Remarks	Please refer the term of "7. storage conditions" in precaution	ns.
3.Rated Current		
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	Within the specified tolerance
	LBM Series	
		•
4.Inductance		
4.Iridaotarioc	LB, LBC, LBR, LBMF Series	
Specified Value		Within the specified tolerance
Specified value	CB, CBC, CBL, CBMF Series Within the specified tolerance LBM Series	
Test Methods and	LB·LBC·LBR·CB·CBC·CBL·LBMF·CBMF·LBM Series	
Remarks	Measuring equipment :LCR Mater (HP4285A or its	equivalent)
5.Q		
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	
	LBM Series Within the specified tolerance	
Test Methods and	LBM Series	·
Remarks	Measuring equipment : LCR Mater(HP4285A or its ed	quivalent)
6.DC Resisitance		
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series Within the specified tolerance	
	LBM Series	
Test Methods and Remarks	Measuring equipment : DC Ohmmeter (HIOKI 3227 or its equ	uivalent)
7.Self-Resonant Fro	equency	
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	Within the specified tolerance
Spoomed value	LBM Series	
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A or its	equivalent)

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8.Temperature Chai	racteristic				
	LBM2016	6			Inductance change : Within±5%
	LB1608	LB2012	LBR2012	CB2012	2
	CBL2012	LB2016	CB2016	LB2518	Inductance change: Within ± 20%
Specified Value	LBR2518	B CB2518	LBC3225	CBC322	225
	LBMF160	08 CBMF1608	LBC2016	CBC201	
	LBC2518	B CBC2518	LB3218		Inductance change : Within±25%
	LBC2012	CBC2012			Inductance change : Within±35%
	Change of	of maximum inductan	ce deviation in	step 1-5	_
	Ston	Tempe	erature(°C)		
	Step	LB, CB Series			
Test Methods and	1		20		
Remarks	2		-40		
	3	20(Referen	ice temperature	e)	
	4	+85(Maximum operating temperature)		rature)	
	5		20		_

9.Rasistance to Fle	xure of Substrate	
Specified Value	LB, LBC, LBR, LBMF Series	No damage.
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	Warp : 2mm(LB·LBC·LBR·CB·CBC·CBL·LBM·L Test substrate : Board according to JIS C0051 Thickness : 0.8mm(LB·LBMF·CBMF1608) : 1.0mm(Others) Pressing jig 10 20 Board Board A5±2mm A5±2mm	BMF•CBMF Series)

10.Body Strength			
	LB, LBC, LBR, LBMF Series		
Specified Value	CB, CBC, CBL, CBMF Series	No damage.	No damage.
	LBM Series		
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM Applied force : 10N Duration : 10sec. LB1608·LBMF1608·CBMF1608 Applied force : 5N Duration : 10sec.		

11.Adhesion of terminal electrode				
	LB, LBC, LBR, LBMF Series		No abnormality.	
Specified Value	CB, CBC, CBL, CBMF Series			
	LBM Series			
Test Methods and Remarks		• CBC • CBL • LBM • LBMF • CBMF : 10N to X and Y directions : 5 sec. : Printed board 8 • LBMF1608 : 5N to X and Y directions : 5 sec. : Printed board		

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12.Resistance to vil	pration			
	LB, LBC, LBR, LBMF Series	Inductance change : Within±10%		
Specified Value	CB, CBC, CBL, CBMF Series	No significant abnormality in appearance.		
•	LBM Series	Inductance change: Within±5% No significant abnormality in appearance.		
Test Methods and Remarks	Vibration type : A Directions : 2 hrs each in Frequency range : 10 to 55 to 6 Amplitude : 1.5mm Mounting method : Soldering on	MF*CBMF: According to JIS C5102 clause 8.2. X, Y and Z directions. Total: 6 hrs 0 Hz(1min.) o printed board s of recovery under the standard condition after the test, followed by the measurement within 4		
Cassified Value	CB, CBC, CBL, CBMF Series			
Specified Value				
	LBM Series			
440.11.122				
14.Solderability	LD LDG LDD LDME C			
0 :5 11/1	LB, LBC, LBR, LBMF Series	A. I		
Specified Value	CB, CBC, CBL, CBMF Series	At least 90% of surface of terminal electrode is covered by new		
	LBM Series			
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM·LE Solder temperature : 245±5°C Duration : 5±0.5sec Flux : Methanol so	MF•CBMF: ution with 25% of colophony		
15.Resistance to so				
	LB, LBC, LBR, LBMF Series	Inductance change : Within±10%		
Specified Value	CB, CBC, CBL, CBMF Series	, and the second		
	LBM Series	Inductance change : Within±5%		
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM·LE 3 times of reflow oven at 230°C MIN	MF • CBMF : or 40sec. with peak temperature at 260 °C for 5sec.		
16.Resisitance to so	olvent			
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series			
	LBM Series			
Test Methods and Remarks	Solvent temperature : Room temperature : Isopropyl alc : Isopropyl alc : 90s. Immersi			
17.Thermal shock				
	LB. LBC. LBR. LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series	Inductance change : Within±10%		
opecineu value		No significant abnormality in appearance.		
T . M .:	LBM Series			
Test Methods and		MF·CBMF: -40~ +85°C, maintain times 30min.,100 cycle		
Remarks	Recovery : At least 2 hrs of	ecovery under the standard condition after the test, followed by the measurement within 48 hrs		

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18.Damp heat life to	est		
. o.b a.mp node mo te	LB, LBC, LBR, LBM	IF Series	
Specified Value	CB, CBC, CBL, CBMF Series		Inductance change : Within±10%
opeomed value	LBM Series		No significant abnormality in appearance.
	Temperature	: 60±2°C	1
Test Methods and Remarks	Humidity	: 90 ~ 2 °C : 90 ~ 95%RH	
	Duration	: 1000 hrs	
	Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the mea		andard condition after the test, followed by the measurement within 48 hrs.
19.Loading under da			
	LB, LBC, LBR, LBMF Series		Inductance change : Within±10%
	CB, CBC, CBL, CBI	MF Series	No significant abnormality in appearance.
Specified Value	LBM Series		
Test Methods and	Temperature	: 60±2°C	
Remarks	Humidity Duration	: 90∼95%RH : 1000 hrs	
	Applied current	: Rated current	
	Recovery	: At least 2 hrs of recovery under the s	andard condition after the test, followed by the measurement within 48 hrs.
20.High temperature	e life test		
	LB, LBC, LBR, LBM		_
Specified Value	CB, CBC, CBL, CBI	MF Series	Inductance change : Within±10%
	LBM Series		No significant abnormality in appearance.
Test Methods and	Temperature	: 85±2°C	
Remarks	Duration Recovery	: 1000 hrs : At least 2 hrs of recovery under the si	andard condition after the test, followed by the measurement within 48 hrs.
		.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	
21.Loading at high t	temperature life test		
21.Loading at high t	temperature life test		Inductance change : Within±10%
21.Loading at high t	LB, LBC, LBR, LBM	IF Series	(LBC3225 Series : Within±20%)
21.Loading at high t	LB, LBC, LBR, LBM		_
	LB, LBC, LBR, LBM		(LBC3225 Series : Within±20%)
	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series	MF Series	(LBC3225 Series : Within±20%)
Specified Value	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature	MF Series : 85±2°C	(LBC3225 Series : Within±20%)
Specified Value Test Methods and	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration	MF Series : 85±2°C : 1000 hrs	(LBC3225 Series : Within±20%)
Specified Value	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature	MF Series : 85±2°C : 1000 hrs : Rated current	(LBC3225 Series : Within±20%)
Specified Value Test Methods and	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current	MF Series : 85±2°C : 1000 hrs : Rated current	(LBC3225 Series : Within±20%) No significant abnormality in appearance. —
Specified Value Test Methods and	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery	MF Series : 85±2°C : 1000 hrs : Rated current	(LBC3225 Series : Within±20%) No significant abnormality in appearance. —
Specified Value Test Methods and Remarks	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery	MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery under the st	(LBC3225 Series : Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs.
Specified Value Test Methods and Remarks	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery	MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery under the st	(LBC3225 Series : Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs. Inductance change : Within±10%
Specified Value Test Methods and Remarks 22.Low temperature	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBM	MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery under the st	(LBC3225 Series : Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs.
Specified Value Test Methods and Remarks 22.Low temperature Specified Value	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature	MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery under the state of the series IF Series MF Series : −40±2°C	(LBC3225 Series : Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs. Inductance change : Within±10%
Specified Value Test Methods and Remarks 22.Low temperature	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration	### Series #### Series #### Series #### Series	(LBC3225 Series : Within±20%) No significant abnormality in appearance.
Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature	### Series #### Series #### Series #### Series	(LBC3225 Series : Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs. Inductance change : Within±10%
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Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Recovery	### Series ### Se	(LBC3225 Series : Within±20%) No significant abnormality in appearance.
Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Recovery on LB, LBC, LBR, LBM	### Series ### Series ### Series ### Series ### Series ### Series ### IT Series ### Series ### IT Series ### Series ### IT Series ### IT Series #### IT Series	(LBC3225 Series : Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs. Inductance change : Within±10% No significant abnormality in appearance. andard condition after the test, followed by the measurement within 48 hrs.
Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks 23.Standard conditions	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Recovery	### Series ### Series ### Series ### Series ### Series ### Series ### IT Series ### Series ### IT Series ### Series ### IT Series ### IT Series #### IT Series	(LBC3225 Series: Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. andard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Standard test conditions Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further
Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Applied current Recovery Elife test LB, LBC, LBR, LBM CB, CBC, CBL, CBI LBM Series Temperature Duration Recovery On LB, LBC, LBR, LBM CB, CBC, CBL, CBI CB, CBC, CBL, CBI	### Series ### Series ### Series ### Series ### Series ### Series ### IT Series ### Series ### IT Series ### Series ### IT Series ### IT Series #### IT Series	(LBC3225 Series: Within±20%) No significant abnormality in appearance. — andard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. andard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Standard test conditions Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:
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[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

PRECAUTIONS

1. Circuit Design

Precautions

♦Operating environment

1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design

Precautions

◆Land pattern design

1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.

Technical

considerations

[Recommended Land Patterns]

Surface Mounting

PRECAUTIONS

- Mounting and soldering conditions should be checked beforehand.
- · Applicable soldering process to those products is reflow soldering only.

3. Considerations for automatic placement

Precautions

- Adjustment of mounting machine
- 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
- 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering

Precautions

◆Reflow soldering(LB and CB Types)

 $1. \ For \ reflow \ soldering \ with \ either \ leaded \ or \ lead-free \ solder, \ the \ profile \ specified \ in \ "point for \ controlling" \ is \ recommended.$

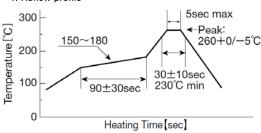
◆Recommended conditions for using a soldering iron

1. Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly.

◆Reflow soldering(LB and CB Types)

1. Reflow profile





- ◆Recommended conditions for using a soldering iron
 - 1. Components can be damaged by excessive heat where soldering conditions exceed the specified range.

5. Cleaning

Precautions

◆Cleaning conditions

Washing by supersonic waves shall be avoided.

Technical considerations

♦Cleaning conditions

If washed by supersonic waves, the products might be broken.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

6. Handling	
Precautions	 ◆Handling 1. Keep the inductors away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the inductors any excessive mechanical shocks.
Technical considerations	 ◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards(splitting along perforations) 1. Planning pattern configurations and the position of products should be carefully performed to minimize stress. ◆Mechanical considerations 1. There is a case to be damaged by a mechanical shock.

7. Storage condi	tions
Precautions	 ♦ Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. • Recommended conditions Ambient temperature:0~40°C / Humidity:Below 70% RH The ambient temperature must be kept below 30°C even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, LB type: Should be used within 6 months from the time of delivery.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.